



IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

First Named  
Inventor : Tom A. Tremmel

Appln. No. : 10/669,736

Filed : September 24, 2003

For : HEAT EXCHANGE SYSTEM CHIP  
TEMPERATURE SENSOR

Docket No.: M366.12-0026

Group Art Unit: 3753

Examiner:

INFORMATION DISCLOSURE STATEMENT

Commissioner for Patents  
P.O. Box 1450  
Alexandria, VA 22313-1450

I HEREBY CERTIFY THAT THIS PAPER IS BEING  
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ALEXANDRIA, VA 22313-1450, THIS

21<sup>ST</sup> DAY OF JANUARY, 2004.

  
PATENT ATTORNEY

The patents or publications listed on the enclosed PTO Form-1449 are submitted pursuant to 37 C.F.R. § 1.97. Copies of the patents or publications cited are enclosed, except as waived by the Official Gazette notice of August 5, 2003 regarding copies of US Patents and Publications.

The information disclosure statement is being filed within the time periods set forth in 37 C.F.R. §1.97(b). Accordingly, no statement or fee is required.

This application relies, under 35 U.S.C. § 120, on the earlier filing date of prior Application No. 10/322,001, filed on December 17, 2002. References listed on the enclosed PTO Form 1449 were submitted to and/or cited by the Office in the prior application and copies are therefore not required to be provided herewith under 37 C.F.R. § 1.98(d).

The Director is authorized to charge any fee deficiency required by this paper or credit any overpayment to Deposit Account No. 23-1123. A duplicate copy of this communication is enclosed.

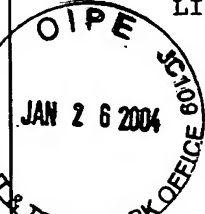
Respectfully submitted,

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BDK/djb

FORM PTO-1449	Atty. Docket No.: M366.12-0026	Appl. No.: 10/669,736
 <p>LIST OF PATENTS AND PUBLICATIONS FOR APPLICANT'S INFORMATION DISCLOSURE STATEMENT</p>	First Named Inventor:	
	Tom A. Tremmel	
	Filing Date September 24, 2003	Group Art: 3753

## U.S. PATENT DOCUMENTS

Examiner Initial	Document No.	Date	Name	Class	Sub Class	Filing Date If Appropriate
AA	4,791,364	12/1988	Kufis et al.	324	760	
AB	4,900,948	2/90	Hamilton	307	149	
AC	4,969,511	11/1990	Person	165	80.4	
AD	4,982,153	1/1991	Collins et al.	324	760	
AE	5,001,423	3/1991	Abrami et al.	324	760	
AF	5,086,269	2/1992	Nobi	324	760	
AG	5,164,661	11/92	Jones	324	158	
AH	5,198,752	3/1993	Miyata et al.	324	760	
AI	5,198,753	3/1993	Hamburgen	324	754	
AJ	5,414,370	5/95	Hashinaga et al.	324	760	
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AL	5,911,897	6/1999	Hamilton	219	497	
AM	5,918,665	7/6/99	Babcock et al.	165	104.33	
AN	5,977,785	11/1999	Burward-Hoy	324	760	
AO	6,288,371	9/11/01	Hamilton et al.	219	530	

## FOREIGN PATENT DOCUMENTS

	Document No.	Date	Country	Class	Sub Class	Translation Yes No
AP	6-101-947	4/1994	Japan			

OTHER ART (Including Author, Title, Date, Pertinent Pages, Etc.)

AQ	"Thermal Control Hardware for Accelerated Run-In Testing of Multi-Chip Modules", IBM Tech. Disclosure Bulletin, Vol. 32, No. 5A, pp. 129-130, Oct. 1989.
AR	
AS	

EXAMINER:

DATE CONSIDERED:

EXAMINER: Initial if citation considered, whether or not citation is in conformance with MPEP 609; draw line through citation if not in conformance and not considered. Include copy of this form with next communication to applicant.